



#### PRELIMINARY SPEC

#### **Features**

- $\bullet$  1.6mmx0.6mm RIGHT ANGLE SMT LED, 1.2mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.





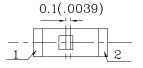


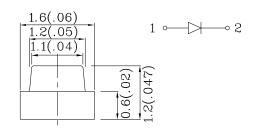
ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

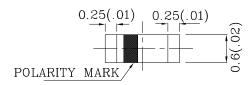
#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		M2BB (InGaN)	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	30	mA	
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA	
Power Dissipation	Рт	111	mW	
Operating Temperature	TA	-40 ~ +85	00	
Storage Temperature	Tstg	-40 ~ +85	°C	
Electrostatic Discharge Thre (HBM)	1000	V		





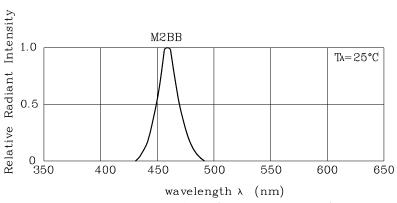


Operating Characteristics (TA=25°C)		M2BB (InGaN)	Unit
Forward Voltage (Typ.) (IF=20mA)	VF	3.2	V
Forward Voltage (Max.) (IF=20mA)	VF	3.7	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	458	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	465	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	22	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	110	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Lumi Inter (IF=2 m	0mA)	Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
ZM2BB87W	Blue	InGaN	Water Clear	110	228	458	110°
Published Date :	FEB 26,2008	Drawin	g No : SDSA6412	V1	Chec	ked : B.L.LIU	P.1/4

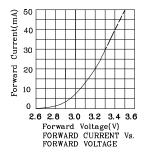


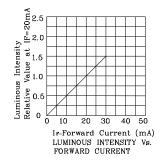


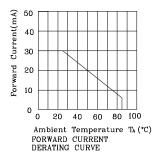


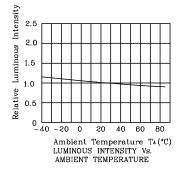
## RELATIVE INTENSITY Vs. WAVELENGTH

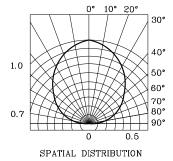
## **❖** M2BB









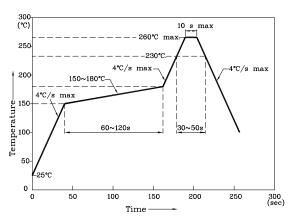


 $Published\ Date: FEB\ 26,2008 \qquad \qquad Drawing\ No: SDSA6412 \qquad \qquad V1 \qquad \qquad Checked: B.L.LIU \qquad P.2/4$ 



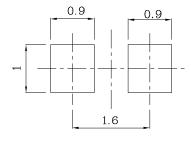


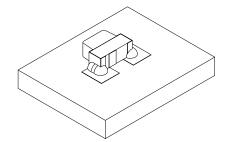
Reflow Soldering Profile For Lead-free SMT Process.



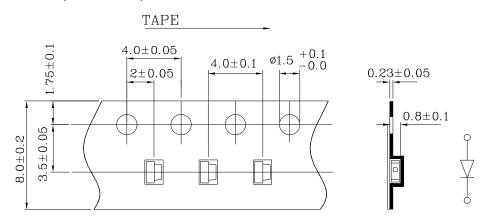
#### NOTES

- 1. Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- ❖ Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)
- **❖** The device has a single mounting surface. The device must be mounted according to the specifications.





\* Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / Luminous Flux: +/-15%
- 3. Forward Voltage:  $\pm -0.1$ V

Note: Accuracy may depend on the sorting parameters.

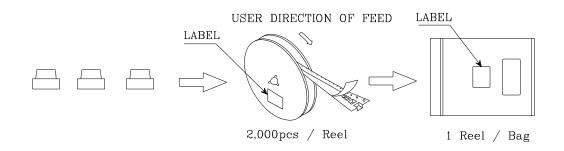
Published Date : FEB 26,2008 Drawing No : SDSA6412 V1 Checked : B.L.LIU P.3/4

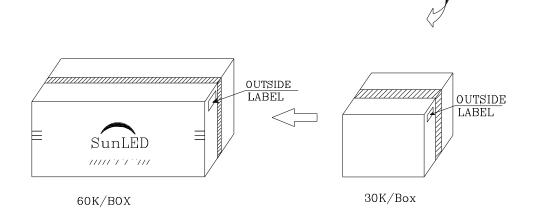


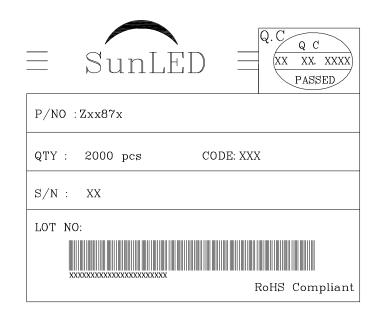


# PACKING & LABEL SPECIFICATIONS

## ZM2BB87W







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